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#### Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

#### Details

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Betano	
Product Status	Active
Core Processor	MIPS32® M4K™
Core Size	32-Bit Single-Core
Speed	40MHz
Connectivity	I <sup>2</sup> C, IrDA, LINbus, PMP, SPI, UART/USART, USB OTG
Peripherals	Brown-out Detect/Reset, DMA, I <sup>2</sup> S, POR, PWM, WDT
Number of I/O	33
Program Memory Size	32KB (32K x 8)
Program Memory Type	FLASH
EEPROM Size	
RAM Size	8K x 8
Voltage - Supply (Vcc/Vdd)	2.3V ~ 3.6V
Data Converters	A/D 13x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	44-VQFN Exposed Pad
Supplier Device Package	44-QFN (8x8)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic32mx220f032dt-i-ml

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

## TABLE 11: PIN NAMES FOR 44-PIN GENERAL PURPOSE DEVICES

## 44-PIN TQFP (TOP VIEW)<sup>(1,2,3,5)</sup>

PIC32MX110F016D PIC32MX120F032D PIC32MX130F064D PIC32MX130F256D PIC32MX150F128D PIC32MX170F256D

44

1

Pin #	Full Pin Name	Pin #	Full Pin Name
1	RPB9/SDA1/CTED4/PMD3/RB9	23	AN4/C1INB/C2IND/RPB2/SDA2/CTED13/RB2
2	RPC6/PMA1/RC6	24	AN5/C1INA/C2INC/RTCC/RPB3/SCL2/RB3
3	RPC7/PMA0/RC7	25	AN6/RPC0/RC0
4	RPC8/PMA5/RC8	26	AN7/RPC1/RC1
5	RPC9/CTED7/PMA6/RC9	27	AN8/RPC2/PMA2/RC2
6	Vss	28	VDD
7	VCAP	29	Vss
8	PGED2/RPB10/CTED11/PMD2/RB10	30	OSC1/CLKI/RPA2/RA2
9	PGEC2/RPB11/PMD1/RB11	31	OSC2/CLKO/RPA3/RA3
10	AN12/PMD0/RB12	32	TDO/RPA8/PMA8/RA8
11	AN11/RPB13/CTPLS/PMRD/RB13	33	SOSCI/RPB4/RB4
12	PGED4 <sup>(4)</sup> /TMS/PMA10/RA10	34	SOSCO/RPA4/T1CK/CTED9/RA4
13	PGEC4 <sup>(4)</sup> /TCK/CTED8/PMA7/RA7	35	TDI/RPA9/PMA9/RA9
14	CVREFOUT/AN10/C3INB/RPB14/SCK1/CTED5/PMWR/RB14	36	RPC3/RC3
15	AN9/C3INA/RPB15/SCK2/CTED6/PMCS1/RB15	37	RPC4/PMA4/RC4
16	AVss	38	RPC5/PMA3/RC5
17	AVDD	39	Vss
18	MCLR	40	VDD
19	VREF+/CVREF+/AN0/C3INC/RPA0/CTED1/RA0	41	PGED3/RPB5/PMD7/RB5
20	VREF-/CVREF-/AN1/RPA1/CTED2/RA1	42	PGEC3/RPB6/PMD6/RB6
21	PGED1/AN2/C1IND/C2INB/C3IND/RPB0/RB0	43	RPB7/CTED3/PMD5/INT0/RB7
22	PGEC1/AN3/C1INC/C2INA/RPB1/CTED12/RB1	44	RPB8/SCL1/CTED10/PMD4/RB8

Note 1: The RPn pins can be used by remappable peripherals. See Table 1 for the available peripherals and Section 11.3 "Peripheral Pin Select" for restrictions.

2: Every I/O port pin (RAx-RCx) can be used as a change notification pin (CNAx-CNCx). See Section 11.0 "I/O Ports" for more information.

3: The metal plane at the bottom of the device is not connected to any pins and is recommended to be connected to Vss externally.

4: This pin function is not available on PIC32MX110F016D and PIC32MX120F032D devices.

5: Shaded pins are 5V tolerant.

#### TABLE 12: PIN NAMES FOR 44-PIN USB DEVICES

## 44-PIN TQFP (TOP VIEW)<sup>(1,2,3,5)</sup>

PIC32MX210F016D PIC32MX220F032D PIC32MX230F064D PIC32MX230F256D PIC32MX250F128D PIC32MX270F256D

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1

Pin #	Full Pin Name	Pin #	Full Pin Name
1		23	
	RPB9/SDA1/CTED4/PMD3/RB9	23	AN4/C1INB/C2IND/RPB2/SDA2/CTED13/PMD2/RB2
2	RPC6/PMA1/RC6		AN5/C1INA/C2INC/RTCC/RPB3/SCL2/PMWR/RB3
3	RPC7/PMA0/RC7	25	AN6/RPC0/RC0
4	RPC8/PMA5/RC8	26	AN7/RPC1/RC1
5	RPC9/CTED7/PMA6/RC9	27	AN8/RPC2/PMA2/RC2
6	Vss	28	VDD
7	VCAP	29	Vss
8	PGED2/RPB10/D+/CTED11/RB10	30	OSC1/CLKI/RPA2/RA2
9	PGEC2/RPB11/D-/RB11	31	OSC2/CLKO/RPA3/RA3
10	VUSB3V3	32	TDO/RPA8/PMA8/RA8
11	AN11/RPB13/CTPLS/PMRD/RB13	33	SOSCI/RPB4/RB4
12	PGED4 <sup>(4)</sup> /TMS/PMA10/RA10	34	SOSCO/RPA4/T1CK/CTED9/RA4
13	PGEC4 <sup>(4)</sup> /TCK/CTED8/PMA7/RA7	35	TDI/RPA9/PMA9/RA9
14	CVREFOUT/AN10/C3INB/RPB14/VBUSON/SCK1/CTED5/RB14	36	AN12/RPC3/RC3
15	AN9/C3INA/RPB15/SCK2/CTED6/PMCS1/RB15	37	RPC4/PMA4/RC4
16	AVss	38	RPC5/PMA3/RC5
17	AVDD	39	Vss
18	MCLR	40	Vdd
19	PGED3/VREF+/CVREF+/AN0/C3INC/RPA0/CTED1/PMD7/RA0	41	RPB5/USBID/RB5
20	PGEC3/VREF-/CVREF-/AN1/RPA1/CTED2/PMD6/RA1	42	VBUS
21	PGED1/AN2/C1IND/C2INB/C3IND/RPB0/PMD0/RB0	43	RPB7/CTED3/PMD5/INT0/RB7
22	PGEC1/AN3/C1INC/C2INA/RPB1/CTED12/PMD1/RB1	44	RPB8/SCL1/CTED10/PMD4/RB8

Note 1: The RPn pins can be used by remappable peripherals. See Table 1 for the available peripherals and Section 11.3 "Peripheral Pin Select" for restrictions.

2: Every I/O port pin (RAx-RCx) can be used as a change notification pin (CNAx-CNCx). See Section 11.0 "I/O Ports" for more information.

3: The metal plane at the bottom of the device is not connected to any pins and is recommended to be connected to Vss externally.

4: This pin function is not available on PIC32MX210F016D and PIC32MX220F032D devices.

5: Shaded pins are 5V tolerant.

## TABLE 13: PIN NAMES FOR 44-PIN GENERAL PURPOSE DEVICES

## 44-PIN VTLA (TOP VIEW)<sup>(1,2,3,5)</sup>

PIC32MX110F016D PIC32MX120F032D PIC32MX130F064D PIC32MX130F256D PIC32MX150F128D PIC32MX170F256D

Pin #	Full Pin Name	Pin #	Full Pin Name
1	RPB9/SDA1/CTED4/PMD3/RB9	23	AN4/C1INB/C2IND/RPB2/SDA2/CTED13/RB2
2	RPC6/PMA1/RC6	24	AN5/C1INA/C2INC/RTCC/RPB3/SCL2/RB3
3	RPC7/PMA0/RC7	25	AN6/RPC0/RC0
4	RPC8/PMA5/RC8	26	AN7/RPC1/RC1
5	RPC9/CTED7/PMA6/RC9	27	AN8/RPC2/PMA2/RC2
6	Vss	28	VDD
7	VCAP	29	Vss
8	PGED2/RPB10/CTED11/PMD2/RB10	30	OSC1/CLKI/RPA2/RA2
9	PGEC2/RPB11/PMD1/RB11	31	OSC2/CLKO/RPA3/RA3
10	AN12/PMD0/RB12	32	TDO/RPA8/PMA8/RA8
11	AN11/RPB13/CTPLS/PMRD/RB13	33	SOSCI/RPB4/RB4
12	PGED4 <sup>(4)</sup> /TMS/PMA10/RA10	34	SOSCO/RPA4/T1CK/CTED9/RA4
13	PGEC4 <sup>(4)</sup> /TCK/CTED8/PMA7/RA7	35	TDI/RPA9/PMA9/RA9
14	CVREFOUT/AN10/C3INB/RPB14/SCK1/CTED5/PMWR/RB14	36	RPC3/RC3
15	AN9/C3INA/RPB15/SCK2/CTED6/PMCS1/RB15	37	RPC4/PMA4/RC4
16	AVss	38	RPC5/PMA3/RC5
17	AVDD	39	Vss
18	MCLR	40	VDD
19	VREF+/CVREF+/AN0/C3INC/RPA0/CTED1/RA0	41	PGED3/RPB5/PMD7/RB5
20	Vref-/CVref-/AN1/RPA1/CTED2/RA1	42	PGEC3/RPB6/PMD6/RB6
21	PGED1/AN2/C1IND/C2INB/C3IND/RPB0/RB0	43	RPB7/CTED3/PMD5/INT0/RB7
22	PGEC1/AN3/C1INC/C2INA/RPB1/CTED12/RB1	44	RPB8/SCL1/CTED10/PMD4/RB8

44

1

Note 1: The RPn pins can be used by remappable peripherals. See Table 1 for the available peripherals and Section 11.3 "Peripheral Pin Select" for restrictions.

2: Every I/O port pin (RAx-RCx) can be used as a change notification pin (CNAx-CNCx). See Section 11.0 "I/O Ports" for more information.

3: The metal plane at the bottom of the device is not connected to any pins and is recommended to be connected to Vss externally.

4: This pin function is not available on PIC32MX110F016D and PIC32MX120F032D devices.

5: Shaded pins are 5V tolerant.

		Pin Nu	mber <sup>(1)</sup>			-	
Pin Name	28-pin QFN	28-pin SSOP/ SPDIP/ SOIC	36-pin VTLA	44-pin QFN/ TQFP/ VTLA	Pin Type	Buffer Type	Description
RC0	—	—	3	25	I/O	ST	PORTC is a bidirectional I/O port
RC1	—	—	4	26	I/O	ST	
RC2	—	—	_	27	I/O	ST	
RC3	—	—	11	36	I/O	ST	_
RC4	—	—	_	37	I/O	ST	_
RC5	—			38	I/O	ST	_
RC6		—	_	2	I/O	ST	_
RC7	—		—	3	I/O	ST	4
RC8	—	—	—	4	I/O	ST	_
RC9		- 40	20	5	I/O	ST	Time and an element all all in must
T1CK T2CK	9 PPS	12	10	34		ST	Timer1 external clock input
T3CK	PPS PPS	PPS PPS	PPS PPS	PPS PPS		ST ST	Timer2 external clock input Timer3 external clock input
T4CK	PPS	PPS	PPS	PPS	1	ST	Timer4 external clock input
T5CK	PPS	PPS	PPS	PPS		ST	Timer5 external clock input
	PPS	PPS	PPS	PPS		ST	UART1 clear to send
U1RTS	PPS	PPS	PPS	PPS		51	
U1RX	PPS PPS	PPS PPS	PPS PPS	PPS PPS	0	ST	UART1 ready to send UART1 receive
U1TX	PPS	PPS	PPS	PPS	-		
					0		UART1 transmit
U2CTS	PPS	PPS	PPS	PPS	I	ST	UART2 clear to send
U2RTS	PPS	PPS	PPS	PPS	0		UART2 ready to send
U2RX	PPS	PPS	PPS	PPS	I	ST	UART2 receive
U2TX	PPS	PPS	PPS	PPS	0		UART2 transmit
SCK1	22	25	28	14	I/O	ST	Synchronous serial clock input/output for SPI1
SDI1	PPS	PPS	PPS	PPS	I	ST	SPI1 data in
SDO1	PPS	PPS	PPS	PPS	0	_	SPI1 data out
SS1	PPS	PPS	PPS	PPS	I/O	ST	SPI1 slave synchronization or frame pulse I/O
SCK2	23	26	29	15	I/O	ST	Synchronous serial clock input/output for SPI2
SDI2	PPS	PPS	PPS	PPS		ST	SPI2 data in
SDO2	PPS	PPS	PPS	PPS	0	_	SPI2 data out
SS2	PPS	PPS	PPS	PPS	I/O	ST	SPI2 slave synchronization or frame pulse I/O
SCL1	14	17	18	44	I/O	ST	Synchronous serial clock input/output for I2C1
	ST = Schm TTL = TTL	MOS compa itt Trigger in input buffer	put with CN	MOS levels		O = Outp PPS = P	Analog input P = Power

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Note 1: Pin numbers are provided for reference only. See the "Pin Diagrams" section for device pin availability.

2: Pin number for PIC32MX1XX devices only.

3: Pin number for PIC32MX2XX devices only.

## 3.0 CPU

Note: This data sheet summarizes the features of the PIC32MX1XX/2XX 28/36/44-pin Family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to **Section 2.** "CPU" (DS60001113), which is available from the *Documentation > Reference Manual* section of the Microchip PIC32 web site (www.microchip.com/pic32). Resources for the MIPS32<sup>®</sup> M4K<sup>®</sup> Processor Core are available at: www.imgtec.com.

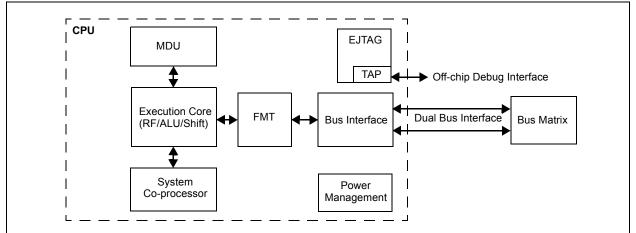
The MIPS32<sup>®</sup> M4K<sup>®</sup> Processor Core is the heart of the PIC32MX1XX/2XX family processor. The CPU fetches instructions, decodes each instruction, fetches source operands, executes each instruction and writes the results of instruction execution to the destinations.

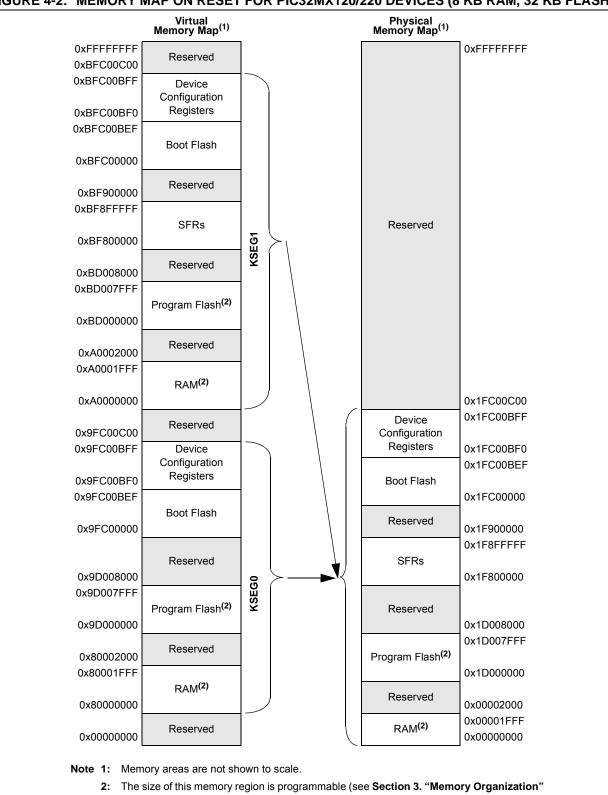
## 3.1 Features

- 5-stage pipeline
- 32-bit address and data paths
- MIPS32 Enhanced Architecture (Release 2)
  - Multiply-accumulate and multiply-subtract instructions
  - Targeted multiply instruction
  - Zero/One detect instructions
  - WAIT instruction
  - Conditional move instructions (MOVN, MOVZ)
  - Vectored interrupts
  - Programmable exception vector base
  - Atomic interrupt enable/disable
  - Bit field manipulation instructions

- MIPS16e<sup>®</sup> code compression
  - 16-bit encoding of 32-bit instructions to improve code density
  - Special PC-relative instructions for efficient loading of addresses and constants
  - SAVE and RESTORE macro instructions for setting up and tearing down stack frames within subroutines
  - Improved support for handling 8 and 16-bit data types
- Simple Fixed Mapping Translation (FMT) mechanism
- · Simple dual bus interface
  - Independent 32-bit address and data buses
  - Transactions can be aborted to improve interrupt latency
- · Autonomous multiply/divide unit
  - Maximum issue rate of one 32x16 multiply per clock
  - Maximum issue rate of one 32x32 multiply every other clock
  - Early-in iterative divide. Minimum 11 and maximum 33 clock latency (dividend (*rs*) sign extension-dependent)
- Power control
  - Minimum frequency: 0 MHz
  - Low-Power mode (triggered by WAIT instruction)
  - Extensive use of local gated clocks
- EJTAG debug and instruction trace
  - Support for single stepping
  - Virtual instruction and data address/value
  - Breakpoints

## FIGURE 3-1: MIPS32<sup>®</sup> M4K<sup>®</sup> PROCESSOR CORE BLOCK DIAGRAM





## FIGURE 4-2: MEMORY MAP ON RESET FOR PIC32MX120/220 DEVICES (8 KB RAM, 32 KB FLASH)

2: The size of this memory region is programmable (see Section 3. "Memory Organization" (DS60001115) in the "*PIC32 Family Reference Manual*") and can be changed by initialization code provided by end-user development tools (refer to the specific development tool documentation for information).

NOTES:

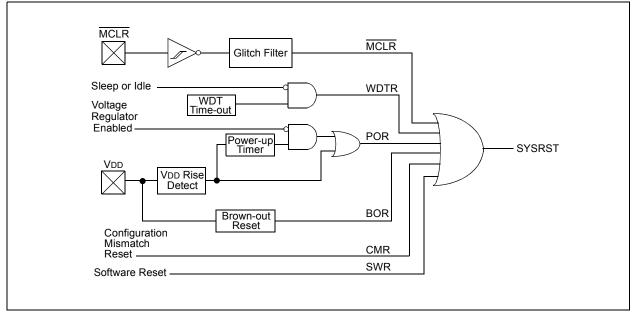
## 6.0 RESETS

Note: This data sheet summarizes the features of the PIC32MX1XX/2XX 28/36/44-pin Family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to **Section 7.** "**Resets**" (DS60001118), which is available from the *Documentation* > *Reference Manual* section of the Microchip PIC32 web site (www.microchip.com/pic32). The Reset module combines all Reset sources and controls the device Master Reset signal, SYSRST. The following is a list of device Reset sources:

- Power-on Reset (POR)
- Master Clear Reset pin (MCLR)
- · Software Reset (SWR)
- Watchdog Timer Reset (WDTR)
- Brown-out Reset (BOR)
- Configuration Mismatch Reset (CMR)

A simplified block diagram of the Reset module is illustrated in Figure 6-1.

## FIGURE 6-1: SYSTEM RESET BLOCK DIAGRAM



## REGISTER 8-1: OSCCON: OSCILLATOR CONTROL REGISTER

- bit 18-16 **PLLMULT<2:0>:** Phase-Locked Loop (PLL) Multiplier bits
  - 111 = Clock is multiplied by 24
  - 110 = Clock is multiplied by 21
  - 101 = Clock is multiplied by 20
  - 100 = Clock is multiplied by 19
  - 011 = Clock is multiplied by 18
  - 010 = Clock is multiplied by 17
  - 001 = Clock is multiplied by 16
  - 000 =Clock is multiplied by 15
- bit 15 Unimplemented: Read as '0'
- bit 14-12 COSC<2:0>: Current Oscillator Selection bits
  - 111 = Internal Fast RC (FRC) Oscillator divided by FRCDIV<2:0> bits (OSCCON<26:24>)
  - 110 = Internal Fast RC (FRC) Oscillator divided by 16
  - 101 = Internal Low-Power RC (LPRC) Oscillator
  - 100 = Secondary Oscillator (Sosc)
  - 011 = Primary Oscillator (Posc) with PLL module (XTPLL, HSPLL or ECPLL)
  - 010 = Primary Oscillator (Posc) (XT, HS or EC)
  - 001 = Internal Fast RC Oscillator with PLL module via Postscaler (FRCPLL)
  - 000 = Internal Fast RC (FRC) Oscillator
- bit 11 Unimplemented: Read as '0'
- bit 10-8 NOSC<2:0>: New Oscillator Selection bits
  - 111 = Internal Fast RC Oscillator (FRC) divided by OSCCON<FRCDIV> bits
  - 110 = Internal Fast RC Oscillator (FRC) divided by 16
  - 101 = Internal Low-Power RC (LPRC) Oscillator
  - 100 = Secondary Oscillator (Sosc)
  - 011 = Primary Oscillator with PLL module (XTPLL, HSPLL or ECPLL)
  - 010 = Primary Oscillator (XT, HS or EC)
  - 001 = Internal Fast Internal RC Oscillator with PLL module via Postscaler (FRCPLL)
  - 000 = Internal Fast Internal RC Oscillator (FRC)

On Reset, these bits are set to the value of the FNOSC Configuration bits (DEVCFG1<2:0>).

bit 7 CLKLOCK: Clock Selection Lock Enable bit

If clock switching and monitoring is disabled (FCKSM<1:0> = 1x):

- 1 = Clock and PLL selections are locked
- 0 = Clock and PLL selections are not locked and may be modified

If clock switching and monitoring is enabled (FCKSM<1:0> = 0x):

Clock and PLL selections are never locked and may be modified.

- bit 6 ULOCK: USB PLL Lock Status bit<sup>(1)</sup>
  - 1 = The USB PLL module is in lock or USB PLL module start-up timer is satisfied
  - 0 =The USB PLL module is out of lock or USB PLL module start-up timer is in progress or the USB PLL is disabled
- bit 5 SLOCK: PLL Lock Status bit
  - 1 = The PLL module is in lock or PLL module start-up timer is satisfied
  - 0 = The PLL module is out of lock, the PLL start-up timer is running, or the PLL is disabled
- bit 4 SLPEN: Sleep Mode Enable bit
  - 1 = The device will enter Sleep mode when a WAIT instruction is executed
  - 0 = The device will enter Idle mode when a WAIT instruction is executed
- **Note 1:** This bit is only available on PIC32MX2XX devices.

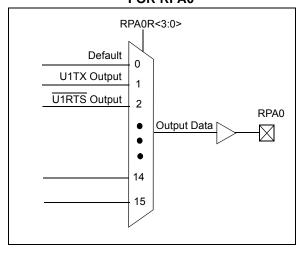
Note: Writes to this register require an unlock sequence. Refer to Section 6. "Oscillator" (DS60001112) in the "PIC32 Family Reference Manual" for details.

#### 11.3.5 OUTPUT MAPPING

In contrast to inputs, the outputs of the PPS options are mapped on the basis of the pin. In this case, a control register associated with a particular pin dictates the peripheral output to be mapped. The RPnR registers (Register 11-2) are used to control output mapping. Like the [*pin name*]R registers, each register contains sets of 4 bit fields. The value of the bit field corresponds to one of the peripherals, and that peripheral's output is mapped to the pin (see Table 11-2 and Figure 11-3).

A null output is associated with the output register reset value of '0'. This is done to ensure that remappable outputs remain disconnected from all output pins by default.

#### FIGURE 11-3: EXAMPLE OF MULTIPLEXING OF REMAPPABLE OUTPUT FOR RPA0



## 11.3.6 CONTROLLING CONFIGURATION CHANGES

Because peripheral remapping can be changed during run time, some restrictions on peripheral remapping are needed to prevent accidental configuration changes. PIC32 devices include two features to prevent alterations to the peripheral map:

- Control register lock sequence
- Configuration bit select lock

## 11.3.6.1 Control Register Lock Sequence

Under normal operation, writes to the RPnR and [*pin name*]R registers are not allowed. Attempted writes appear to execute normally, but the contents of the registers remain unchanged. To change these registers, they must be unlocked in hardware. The register lock is controlled by the Configuration bit, IOLOCK (CFGCON<13>). Setting IOLOCK prevents writes to the control registers; clearing IOLOCK allows writes.

To set or clear the IOLOCK bit, an unlock sequence must be executed. Refer to **Section 6. "Oscillator"** (DS60001112) in the *"PIC32 Family Reference Manual"* for details.

## 11.3.6.2 Configuration Bit Select Lock

As an additional level of safety, the device can be configured to prevent more than one write session to the RPnR and [*pin name*]R registers. The Configuration bit, IOL1WAY (DEVCFG3<29>), blocks the IOLOCK bit from being cleared after it has been set once. If IOLOCK remains set, the register unlock procedure does not execute, and the PPS control registers cannot be written to. The only way to clear the bit and reenable peripheral remapping is to perform a device Reset.

In the default (unprogrammed) state, IOL1WAY is set, restricting users to one write session.

## 12.0 TIMER1

Note: This data sheet summarizes the features of the PIC32MX1XX/2XX 28/36/44-pin Family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to **Section 14. "Timers"** (DS60001105), which is available from the *Documentation* > *Reference Manual* section of the Microchip PIC32 web site (www.microchip.com/pic32).

This family of PIC32 devices features one synchronous/asynchronous 16-bit timer that can operate as a free-running interval timer for various timing applications and counting external events. This timer can also be used with the Low-Power Secondary Oscillator (Sosc) for Real-Time Clock (RTC) applications.

FIGURE 12-1: TIMER1 BLOCK DIAGRAM

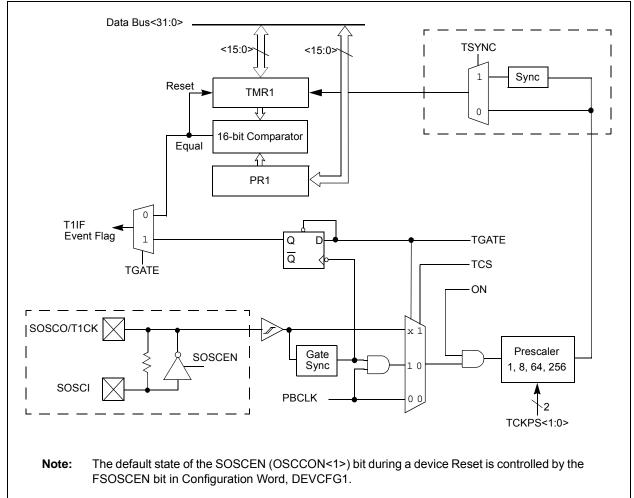
The following modes are supported:

- · Synchronous Internal Timer
- Synchronous Internal Gated Timer
- Synchronous External Timer
- Asynchronous External Timer

## 12.1 Additional Supported Features

- · Selectable clock prescaler
- Timer operation during CPU Idle and Sleep mode
- Fast bit manipulation using CLR, SET and INV registers
- Asynchronous mode can be used with the Sosc to function as a Real-Time Clock (RTC)

Figure 12-1 illustrates a general block diagram of Timer1.



## 17.1 SPI Control Registers

## TABLE 17-1: SPI1 AND SPI2 REGISTER MAP

ess		Ċ,								Bi	ts								
Virtual Address (BF80_#)	Register Name <sup>(1)</sup>	Bit Range	31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	19/3	18/2	17/1	16/0	All Resets
5800	SPI1CON	31:16	FRMEN	FRMSYNC	FRMPOL	MSSEN	FRMSYPW	FF	RMCNT<2:(	)>	MCLKSEL	—	_	-	—	_	SPIFE	ENHBUF	0000
3800	SFILCON	15:0	ON	_	SIDL	DISSDO	MODE32	MODE16	SMP	CKE	SSEN	CKP	MSTEN	DISSDI	STXISE	L<1:0>	SRXISE	EL<1:0>	0000
5910	SPI1STAT	31:16	—	_	_		RXE	BUFELM<4:	0>		—	—	-		TX	BUFELM<4	:0>		0000
5610		15:0	_	—	—	FRMERR	SPIBUSY	—	—	SPITUR	SRMT	SPIROV	SPIRBE	—	SPITBE	—	SPITBF	SPIRBF	0008
5820	SPI1BUF	31:16	31:16 DATA<31:0>										0000						
3020		15:0								Brance	.01.0								0000
5830	SPI1BRG	31:16	—	—	_	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
0000		15:0									0000								
		31:16	—	—	—	—	—	—	—	—	—	—	_	_	—	_	—	—	0000
5840	SPI1CON2	15:0	SPI SGNEXT	_		FRM ERREN	SPI ROVEN	SPI TUREN	IGNROV	IGNTUR	AUDEN	—	-	-	AUD MONO	_	AUDMC	)D<1:0>	0000
5400	SPI2CON	31:16	FRMEN	FRMSYNC	FRMPOL	MSSEN	FRMSYPW	FF	RMCNT<2:(	)>	MCLKSEL	—			_		SPIFE	ENHBUF	0000
5A00	3F1200N	15:0	ON	_	SIDL	DISSDO	MODE32	MODE16	SMP	CKE	SSEN	CKP	MSTEN	DISSDI	STXISE	L<1:0>	SRXISE	EL<1:0>	0000
5410	SPI2STAT	31:16	—	_			RXE	BUFELM<4:	0>		_	-			TX	BUFELM<4	:0>		0000
SATU	3F1231AI	15:0	_	_	_	FRMERR	SPIBUSY	_	_	SPITUR	SRMT	SPIROV	SPIRBE	_	SPITBE	_	SPITBF	SPIRBF	0008
5A20	SPI2BUF	31:16								DATA<	31.0>								0000
5420		15:0								Brance									0000
5A30	SPI2BRG	31:16	—	—	_	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
5730		15:0		—	—						E	3RG<12:0>							0000
		31:16	—	—	—	_	—	_	—	—	—	—	_	—	—	—	—	—	0000
5A40	SPI2CON2	15:0	SPI SGNEXT	—	_	FRM ERREN	SPI ROVEN	SPI TUREN	IGNROV	IGNTUR	AUDEN	—	_	_	AUD MONO	_	AUDMC	)D<1:0>	0000

Legend: x = unknown value on Reset; — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: All registers in this table except SPIxBUF have corresponding CLR, SET and INV registers at their virtual addresses, plus offsets of 0x4, 0x8 and 0xC, respectively. See Section 11.2 "CLR, SET and INV Registers" for more information.

IC32MX1XX/2XX 28/36/44-PIN FAMILY

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0	
24.24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	R/W-0	
31:24		_	_	_	—	_	_	ADM_EN	
00.40	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
23:16	ADDR<7:0>								
45.0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R-0	R-1	
15:8	UTXISE	L<1:0>	UTXINV	URXEN	UTXBRK	UTXEN	UTXBF	TRMT	
7.0	R/W-0	R/W-0	R/W-0	R-1	R-0	R-0	R/W-0	R-0	
7:0	URXISE	L<1:0>	ADDEN	RIDLE	PERR	FERR	OERR	URXDA	

#### REGISTER 19-2: UxSTA: UARTx STATUS AND CONTROL REGISTER

## Legend:

	0				
R = Readable bit W = Write		W = Writable bit	U = Unimplemented bit, read as '0'		
	-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

bit 31-25 Unimplemented: Read as '0'

- bit 24 ADM\_EN: Automatic Address Detect Mode Enable bit
  - 1 = Automatic Address Detect mode is enabled
  - 0 = Automatic Address Detect mode is disabled
- bit 23-16 ADDR<7:0>: Automatic Address Mask bits

When the ADM\_EN bit is '1', this value defines the address character to use for automatic address detection.

- bit 15-14 UTXISEL<1:0>: TX Interrupt Mode Selection bits
  - 11 = Reserved, do not use
  - 10 = Interrupt is generated and asserted while the transmit buffer is empty
  - 01 = Interrupt is generated and asserted when all characters have been transmitted
  - 00 = Interrupt is generated and asserted while the transmit buffer contains at least one empty space

#### bit 13 **UTXINV:** Transmit Polarity Inversion bit

If IrDA mode is disabled (i.e., IREN (UxMODE<12>) is '0'):

- 1 = UxTX Idle state is '0'
- 0 = UxTX Idle state is '1'

If IrDA mode is enabled (i.e., IREN (UxMODE<12>) is '1'):

- 1 = IrDA encoded UxTX Idle state is '1'
- 0 = IrDA encoded UxTX Idle state is '0'
- bit 12 URXEN: Receiver Enable bit
  - 1 = UARTx receiver is enabled. UxRX pin is controlled by UARTx (if ON = 1)
  - 0 = UARTx receiver is disabled. UxRX pin is ignored by the UARTx module. UxRX pin is controlled by port.

#### bit 11 UTXBRK: Transmit Break bit

- 1 = Send Break on next transmission. Start bit followed by twelve '0' bits, followed by Stop bit; cleared by hardware upon completion
- 0 = Break transmission is disabled or completed
- bit 10 UTXEN: Transmit Enable bit
  - 1 = UARTx transmitter is enabled. UxTX pin is controlled by UARTx (if ON = 1).
  - 0 = UARTx transmitter is disabled. Any pending transmission is aborted and buffer is reset. UxTX pin is controlled by port.
- bit 9 UTXBF: Transmit Buffer Full Status bit (read-only)
  - 1 = Transmit buffer is full
    - 0 = Transmit buffer is not full, at least one more character can be written
- bit 8 TRMT: Transmit Shift Register is Empty bit (read-only)
  - 1 = Transmit shift register is empty and transmit buffer is empty (the last transmission has completed)
  - 0 = Transmit shift register is not empty, a transmission is in progress or queued in the transmit buffer

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31.24	—	—		_	_	_	—	_
00.40	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23:16	—	—	_	_	_		—	_
45.0	R/W-0	R/W-0	R/W-0	U-0	U-0	U-0	U-0	R-0
15:8	ON <sup>(1)</sup>	COE	CPOL <sup>(2)</sup>	_	—	—	—	COUT
7.0	R/W-1	R/W-1	U-0	R/W-0	U-0	U-0	R/W-1	R/W-1
7:0	EVPOL	_<1:0>		CREF	_	_	CCH	<1:0>

#### REGISTER 23-1: CMXCON: COMPARATOR CONTROL REGISTER

## Legend:

R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'				
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown			

#### bit 31-16 Unimplemented: Read as '0'

- bit 15 **ON:** Comparator ON bit<sup>(1)</sup>
  - 1 = Module is enabled. Setting this bit does not affect the other bits in this register
  - 0 = Module is disabled and does not consume current. Clearing this bit does not affect the other bits in this register
- bit 14 **COE:** Comparator Output Enable bit
  - 1 = Comparator output is driven on the output CxOUT pin
  - 0 = Comparator output is not driven on the output CxOUT pin
- bit 13 **CPOL:** Comparator Output Inversion bit<sup>(2)</sup>
  - 1 = Output is inverted
  - 0 = Output is not inverted
- bit 12-9 Unimplemented: Read as '0'
- bit 8 **COUT:** Comparator Output bit
  - 1 = Output of the Comparator is a '1'
  - 0 = Output of the Comparator is a '0'
- bit 7-6 **EVPOL<1:0>:** Interrupt Event Polarity Select bits
  - 11 = Comparator interrupt is generated on a low-to-high or high-to-low transition of the comparator output
  - 10 = Comparator interrupt is generated on a high-to-low transition of the comparator output
  - 01 = Comparator interrupt is generated on a low-to-high transition of the comparator output
  - 00 = Comparator interrupt generation is disabled
- bit 5 Unimplemented: Read as '0'
- bit 4 CREF: Comparator Positive Input Configure bit
  - 1 = Comparator non-inverting input is connected to the internal CVREF
  - 0 = Comparator non-inverting input is connected to the CXINA pin
- bit 3-2 Unimplemented: Read as '0'
- bit 1-0 CCH<1:0>: Comparator Negative Input Select bits for Comparator
  - 11 = Comparator inverting input is connected to the IVREF
  - 10 = Comparator inverting input is connected to the CxIND pin
  - 01 = Comparator inverting input is connected to the CxINC pin
  - 00 = Comparator inverting input is connected to the CxINB pin
- **Note 1:** When using the 1:1 PBCLK divisor, the user's software should not read/write the peripheral's SFRs in the SYSCLK cycle immediately following the instruction that clears the module's ON bit.
  - 2: Setting this bit will invert the signal to the comparator interrupt generator as well. This will result in an interrupt being generated on the opposite edge from the one selected by EVPOL<1:0>.

## PIC32MX1XX/2XX 28/36/44-PIN FAMILY

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0		
24.24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0		
31:24	—	—	_	—	_		_	—		
22:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0		
23:16	—	—	-	—	_	_	-	—		
45.0	U-0	U-0	R/W-0	R/W-0	U-0	U-0	U-0	U-0		
15:8	—	—	IOLOCK <sup>(1)</sup>	PMDLOCK <sup>(1)</sup>				—		
7.0	U-0	U-0	U-0	U-0	R/W-1	U-0	U-1	R/W-1		
7:0	_			_	JTAGEN		_	TDOEN		

### **REGISTER 27-5: CFGCON: CONFIGURATION CONTROL REGISTER**

## Legend:

Logona.						
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'				
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown			

#### bit 31-14 Unimplemented: Read as '0'

- bit 13 IOLOCK: Peripheral Pin Select Lock bit<sup>(1)</sup>
  - 1 = Peripheral Pin Select is locked. Writes to PPS registers is not allowed.
  - 0 = Peripheral Pin Select is not locked. Writes to PPS registers is allowed.
- bit 12 PMDLOCK: Peripheral Module Disable bit<sup>(1)</sup>
  - 1 = Peripheral module is locked. Writes to PMD registers is not allowed.
  - 0 = Peripheral module is not locked. Writes to PMD registers is allowed.

#### bit 11-4 Unimplemented: Read as '0'

- bit 3 JTAGEN: JTAG Port Enable bit
  - 1 = Enable the JTAG port
    - 0 = Disable the JTAG port
- bit 2-1 Unimplemented: Read as '1'
- bit 0 **TDOEN:** TDO Enable for 2-Wire JTAG bit
  - 1 = 2-wire JTAG protocol uses TDO
  - 0 = 2-wire JTAG protocol does not use TDO
- Note 1: To change this bit, the unlock sequence must be performed. Refer to Section 6. "Oscillator" (DS60001112) in the "PIC32 Family Reference Manual" for details.

NOTES:

DC CHARACTERISTICS				$\begin{array}{l} \mbox{Standard Operating Conditions: 2.3V to 3.6V} \\ \mbox{(unless otherwise stated)} \\ \mbox{Operating temperature} & -40^{\circ}C \leq TA \leq +85^{\circ}C \mbox{ for Industrial} \\ & -40^{\circ}C \leq TA \leq +105^{\circ}C \mbox{ for V-temp} \end{array}$					
Param. No.	Symbol	Characteristics	Min.	Typical <sup>(1)</sup>	Max.	Units	Conditions		
		Program Flash Memory <sup>(3)</sup>							
D130	Eр	Cell Endurance	20,000	—	_	E/W	—		
D131	Vpr	VDD for Read	2.3	—	3.6	V	—		
D132	VPEW	VDD for Erase or Write	2.3	—	3.6	V	—		
D134	Tretd	Characteristic Retention	20	—	_	Year	Provided no other specifications are violated		
D135	IDDP	Supply Current during Programming	_	10	_	mA	—		
	Tww	Word Write Cycle Time	—	411	_	es	See Note 4		
D136	Trw	Row Write Cycle Time	—	6675	_	Cycles	See Note 2,4		
D137	TPE	Page Erase Cycle Time	—	20011	_		See Note 4		
	TCE	Chip Erase Cycle Time	—	80180	_	FRC	See Note 4		

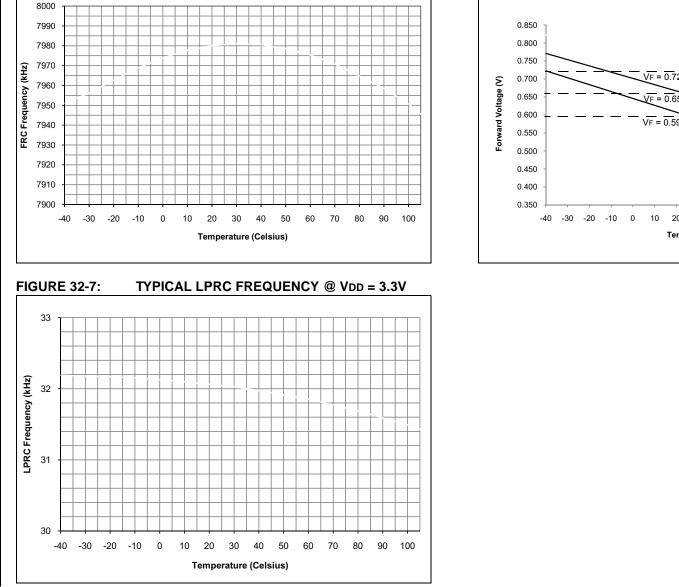
## TABLE 30-12: DC CHARACTERISTICS: PROGRAM MEMORY

**Note 1:** Data in "Typical" column is at 3.3V, 25°C unless otherwise stated.

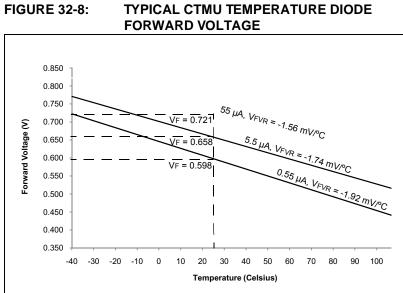
2: The minimum SYSCLK for row programming is 4 MHz. Care should be taken to minimize bus activities during row programming, such as suspending any memory-to-memory DMA operations. If heavy bus loads are expected, selecting Bus Matrix Arbitration mode 2 (rotating priority) may be necessary. The default Arbitration mode is mode 1 (CPU has lowest priority).

**3:** Refer to the *"PIC32 Flash Programming Specification"* (DS60001145) for operating conditions during programming and erase cycles.

4: This parameter depends on FRC accuracy (See Table 30-19) and FRC tuning values (See Register 8-2).



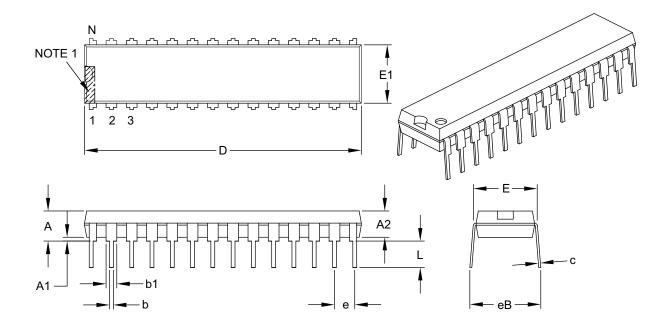
TYPICAL FRC FREQUENCY @ VDD = 3.3V



**FIGURE 32-6:** 

## 28-Lead Skinny Plastic Dual In-Line (SP) – 300 mil Body [SPDIP]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	INCHES			
Dimension Limits		MIN	NOM	MAX
Number of Pins	Ν	28		
Pitch	е	.100 BSC		
Top to Seating Plane	Α	-	-	.200
Molded Package Thickness	A2	.120	.135	.150
Base to Seating Plane	A1	.015	-	-
Shoulder to Shoulder Width	E	.290	.310	.335
Molded Package Width	E1	.240	.285	.295
Overall Length	D	1.345	1.365	1.400
Tip to Seating Plane	L	.110	.130	.150
Lead Thickness	С	.008	.010	.015
Upper Lead Width	b1	.040	.050	.070
Lower Lead Width	b	.014	.018	.022
Overall Row Spacing §	eB	-	-	.430

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.

2. § Significant Characteristic.

3. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" per side.

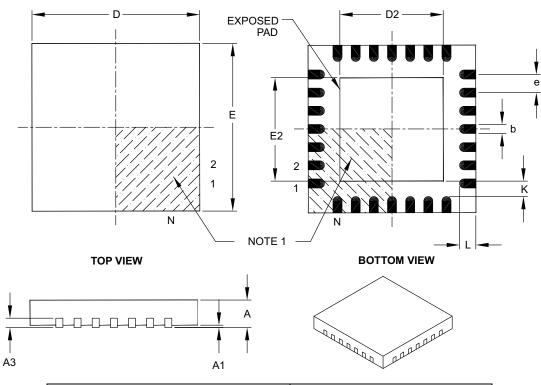
4. Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing C04-070B

# 28-Lead Plastic Quad Flat, No Lead Package (ML) – 6x6 mm Body [QFN] with 0.55 mm Contact Length

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	MILLIMETERS				
Dimension Limits		MIN	NOM	MAX	
Number of Pins	Ν	28			
Pitch	е	0.65 BSC			
Overall Height	Α	0.80	0.90	1.00	
Standoff	A1	0.00	0.02	0.05	
Contact Thickness	A3	0.20 REF			
Overall Width	E	6.00 BSC			
Exposed Pad Width	E2	3.65	3.70	4.20	
Overall Length	D	6.00 BSC			
Exposed Pad Length	D2	3.65	3.70	4.20	
Contact Width	b	0.23	0.30	0.35	
Contact Length	L	0.50	0.55	0.70	
Contact-to-Exposed Pad	К	0.20	-	-	

#### Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.

2. Package is saw singulated.

3. Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-105B